

200W LOW CAPACITANCE FLIP CHIP TVS ARRAY

DESCRIPTION

The LC0406FCxxC Series Flip Chips employ advanced silicon P/N junction technology for unmatched board-level transient voltage protection against Electrostatic Discharge (ESD) and Electrical Fast Transients (EFT). Developed specifically for high-density circuit protection, this series meets the IEC 61000-4-2 and 61000-4-4 requirements. These devices are ideally suited for handheld devices, PCMCIA and SMART cards.

This low capacitance series provides ESD protection greater than 25 kilovolts with a peak pulse power dissipation of 200 Watts per line for an 8/20µs waveform. In addition, the LC0406FCxxC series features superior clamping performance, low leakage current characteristics and a response time of less than a nanosecond. Their low inductance virtually eliminates overshoot voltage due to package inductance.

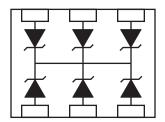
FEATURES

- Compatible with IEC 61000-4-2 (ESD): Air 15kV, Contact 8kV
- Compatible with IEC 61000-4-4 (EFT): 40A, 5/50ns
- ESD Protection > 25 kilovolts
- Available in Voltages Ranging from 3.3V to 36V
- 200 Watts Peak Pulse Power per Line (tp = 8/20μs)
- Protection for 3 to 5 Lines
- Bidirectional and Monolithic Structure
- Low Clamping Voltage
- Low Capacitance
- RoHS Compliant
- REACH Compliant

MECHANICAL CHARACTERISTICS

- Standard EIA Chip Size: 0406
- Approximate Weight: 0.73 milligrams
- Lead-Free Plating
- Solder Reflow Temperature:
- Lead-Free Sn/Ag/Cu, 96/3.5/0.5: 260-270°C
- Flammability Rating UL 94V-0
- 8mm Tape per EIA Standard 481
- Top Contacts: Solder Bump 0.004" in Height (Nominal)

PIN CONFIGURATION



APPLICATIONS

- Cellular Phones
- MCM Boards
- Wireless Communication Circuits
- IR LEDs
- SMART & PCMCIA Cards

TYPICAL DEVICE CHARACTERISTICS

| MAXIMUM RATINGS @ 25°C Unless Otherwise Specified | | | | | | | | |
|---------------------------------------------------|------------------|------------|-------|--|--|--|--|--|
| PARAMETER SYMBOL VALUE UNITS | | | | | | | | |
| Peak Pulse Power (tp = 8/20µs) - See Figure 1 | P _{pp} | 200 | Watts | | | | | |
| Operating Temperature | T _A | -55 to 150 | °C | | | | | |
| Storage Temperature | Т _{stg} | -55 to 150 | °C | | | | | |

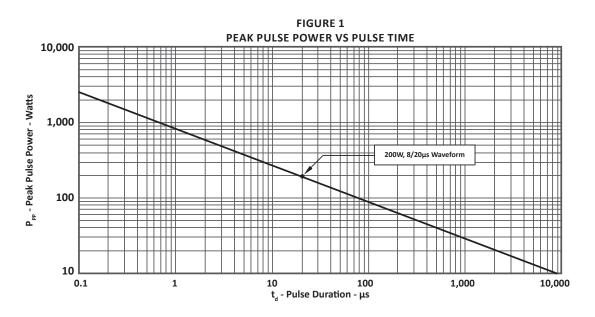
| ELECTRICAL CHARACTERISTICS PER LINE @ 25°C Unless Otherwise Specified | | | | | | | | | |
|-----------------------------------------------------------------------|---------------------------------------------------|------------------------------------------------------------------------|------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------|------------------------------------------------|--|--|--|
| PART NUMBER (Note 1) | RATED STAND-OFF VOLTAGE V WM VOLTS | MINIMUM BREAKDOWN VOLTAGE @ 1mA V _(BR) VOLTS | MAXIMUM CLAMPING VOLTAGE (Fig. 2) @ I _p = 1A V _c VOLTS | MAXIMUM CLAMPING VOLTAGE (Fig. 2) @ 8/20µS V _c @ I _{PP} | MAXIMUM LEAKAGE CURRENT (Note 2) @V _{WM} Ι _D μΑ | TYPICAL CAPACITANCE @0V, 1MHz C pF | | | |
| LC0406FC3.3C | 3.3 | 4.0 | 7.0 | 12.5V @ 16A | 75* | 70 | | | |
| LC0406FC05C | 5.9 | 6.0 | 11.0 | 13.0 @ 15A | 10** | 35 | | | |
| LC0406FC08C | 8.0 | 8.5 | 13.2 | 18.0V @ 11A | 1 | 32 | | | |
| LC0406FC12C | 12.0 | 13.3 | 19.8 | 26.9V @ 7.4A | 1 | 30 | | | |
| LC0406FC15C | 15.0 | 16.7 | 25.4 | 34.5V @ 5.8A | 1 | 25 | | | |
| LC0406FC24C | 24.0 | 26.7 | 37.2 | 50.6V @ 4A | 1 | 20 | | | |
| LC0406FC36C | 36.0 | 40.0 | 70.0 | 80.0V @ 2.5A | 1 | 18 | | | |

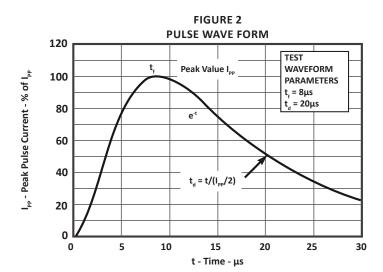
NOTES

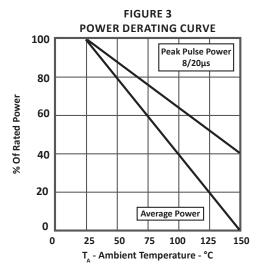
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All devices are bidirectional. Electrical characteristics apply in both directions.
*Maximum leakage current < 5µA @ 2.8V. **Maximum leakage current < 500nA @ 3.3V.

TYPICAL DEVICE CHARACTERISTICS





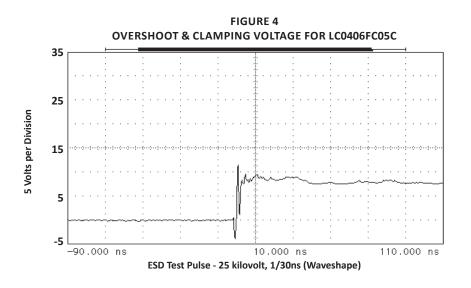


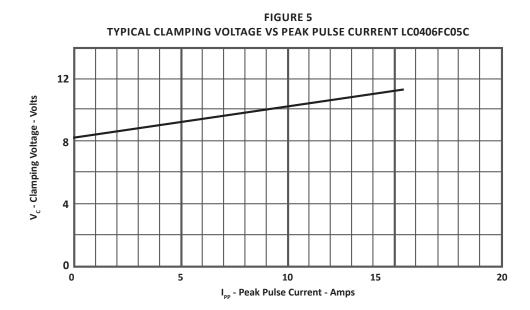
TYPICAL DEVICE CHARACTERISTICS

PROJEK DEV

CES

Only One Name Means ProTek'Tion™



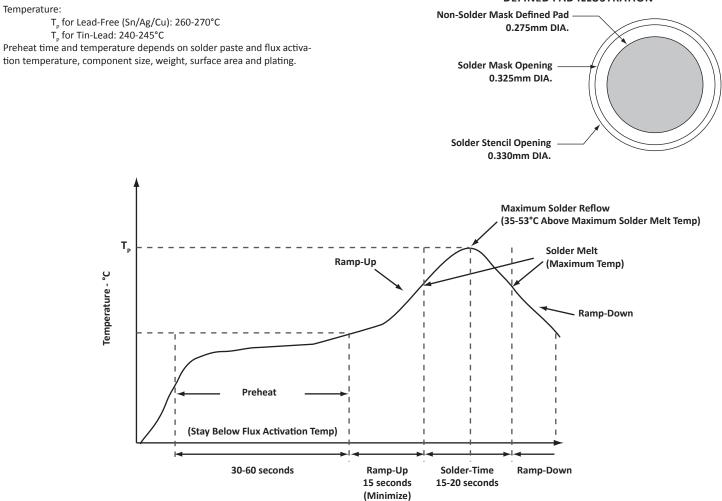


SOLDER REFLOW INFORMATION

| PRINTED CIRCUIT BOARD RECOMMENDATIONS | | | | | | |
|---------------------------------------------------------------|------------------------------|--|--|--|--|--|
| PARAMETER | VALUE | | | | | |
| Pad Size on PCB | 0.275mm | | | | | |
| Pad Shape | Round | | | | | |
| Pad Definition | Non-Solder Mask Defined Pads | | | | | |
| Solder Mask Opening | 0.325mm Round | | | | | |
| Solder Stencil Thickness | 0.150mm | | | | | |
| Solder Stencil Aperture Opening (Laser cut, 5% tapered walls) | 0.330mm Round | | | | | |
| Solder Paste Type | No Clean | | | | | |
| Pad Protective Finish | OSP (Entek Cu Plus 106A) | | | | | |
| Tolerance - Edge To Corner Ball | ±50µm | | | | | |
| Solder Ball Side Coplanarity | ±20µm | | | | | |
| Maximum Dwell Time Above Liquidous (183°C) | 60 seconds | | | | | |
| Soldering Maximum Temperature | 270°C | | | | | |

REQUIREMENTS

RECOMMENDED NON-SOLDER MASK DEFINED PAD ILLUSTRATION



0406 PACKAGE INFORMATION

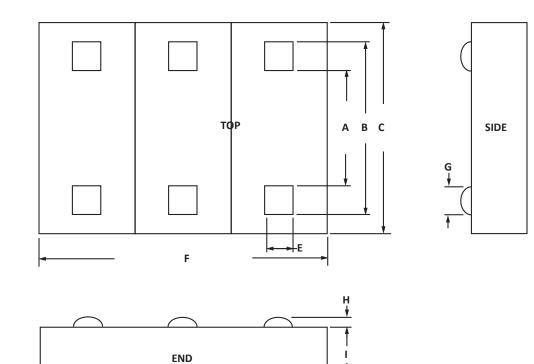
| OUTLINE DIMENSIONS | | | | | | | | | | |
|--------------------|--------------|---------------|-------------|-------|--|--|--|--|--|--|
| | MILLIN | IETERS | INC | HES | | | | | | |
| DIM | MIN | MAX | MIN | MAX | | | | | | |
| А | A 0.56 0.022 | | | | | | | | | |
| В | 0. | 86 | 0.034 | | | | | | | |
| С | 0.98 | 1.02 | 0.038 0.040 | | | | | | | |
| E | 0.15 | 5 SQ | 0.006 SQ | | | | | | | |
| F | 1.47 | 1.53 | 0.058 | 0.060 | | | | | | |
| G | 0. | 0.15 0.006 | | | | | | | | |
| н | 0.076 | 0.127 | 0.003 0.009 | | | | | | | |
| I | 0.4 | 106 | 0.0 |)16 | | | | | | |
| NOTE | NOTES | | | | | | | | | |

NOTES

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1. Controlling dimensions in inches.

2. Decimal tolerance: .xxx \pm 0.05mm (0.002").



0406 PACKAGE INFORMATION

| | OPTION 1 - LAYOUT DIMENSIONS | | | | | | | |
|-------|-------------------------------------|----------|--|--|--|--|--|--|
| | MILLIMETERS | INCHES | | | | | | |
| DIM | NOMINAL | NOMINAL | | | | | | |
| А | 0.51 | 0.020 | | | | | | |
| С | 0.30 | 0.012 | | | | | | |
| D | 0.46 | 0.018 | | | | | | |
| E | 0.20 | 0.008 | | | | | | |
| F | 0.15 SQ | 0.006 SQ | | | | | | |
| G | 0.71 | 0.028 | | | | | | |
| н | 0.99 | 0.039 | | | | | | |
| I | 0.51 | 0.020 | | | | | | |
| NOTES | | | | | | | | |

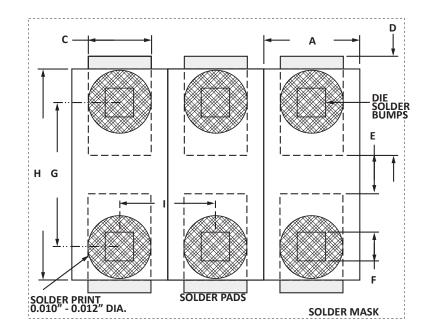
NOTES

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1. Controlling dimensions in inches.

2. Decimal tolerance: .xxx ± 0.05mm (0.002").

3. Preferred: Usign 0.1mm (0.004") stencil.



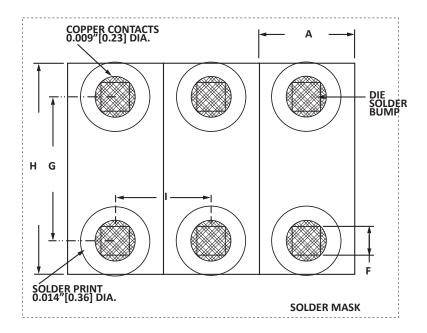
| OPTION 2 - LAYOUT DIMENSIONS | | | | | | | | |
|-------------------------------------|-------------|----------|--|--|--|--|--|--|
| DIM | MILLIMETERS | INCHES | | | | | | |
| DIM | NOMINAL | NOMINAL | | | | | | |
| А | 0.51 | 0.020 | | | | | | |
| F | 0.15 SQ | 0.006 SQ | | | | | | |
| G | 0.71 | 0.028 | | | | | | |
| н | 0.99 | 0.039 | | | | | | |
| I | 0.51 | 0.020 | | | | | | |
| | | | | | | | | |

NOTES

1. Controlling dimensions in inches.

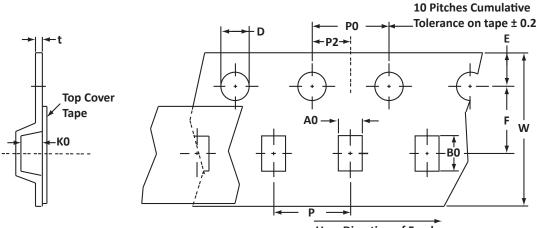
2. Decimal tolerance: .xxx \pm 0.05mm (0.002").

3. Preferred: Usign 0.1mm (0.004") stencil.



TAPE AND REEL INFORMATION

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User Direction of Feed

| SPECIFICATIONS | | | | | | | | | | | | |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------|-------------|-----------------|-------------|-----------------|-------------|-------------|-------------|-------------|-------------|-------------|------|
| REEL DIA. | TAPE WIDTH | A0 | В0 | ко | D | E | F | w | PO | P2 | Р | Tmax |
| 178(7") | 8 | 0.80 ± 0.10 | 1.20 ± 0.10 | 0.70 ± 0.10 | 1.50 ± 0.10 | 1.75 ± 0.10 | 3.50 ± 0.05 | 8.00 ± 0.20 | 4.00 ± 0.12 | 2.00 ± 0.05 | 2.00 ± 0.10 | 0.25 |
| 178(7") 8 0.80 ± 0.10 1.20 ± 0.10 0.70 ± 0.10 1.75 ± 0.10 3.50 ± 0.05 8.00 ± 0.20 4.00 ± 0.12 2.00 ± 0.05 2.00 ± 0.10 0.25 NOTES 1. Dimensions in millimeters. 2. Op view of tape. Solder bumps are face down in tape package. 3. Orientation: preferred stencil - 0.1mm (0.004"). 4. Surface mount product is taped and reeled in accordance with EIA 481. 5. 8mm plastic tape: 7" Reels - 5,000. 6. Marking on reel: part number, date code and lot number. Interview of tape. Intervi | | | | | | | | | | | | |
| Package outline, pad layout and tape specifications per document number 06023.R4 9/09. | | | | | | | | | | | | |

| ORDERING INFORMATION | | | | | | | | | | |
|------------------------------------|-----------------|-------------|----------|-----------|----------|--|--|--|--|--|
| BASE PART NUMBER (xx = Voltage) | LEADFREE SUFFIX | TAPE SUFFIX | QTY/REEL | REEL SIZE | TUBE QTY | | | | | |
| LC0406FCxxC | -LF | -T75-1 | 5,000 | 7″ | n/a | | | | | |

COMPANY INFORMATION

COMPANY PROFILE

ProTek Devices, based in Tempe, Arizona USA, is a manufacturer of Transient Voltage Suppression (TVS) products designed specifically for the protection of electronic systems from the effects of lightning, Electrostatic Discharge (ESD), Nuclear Electromagnetic Pulse (NEMP), inductive switching and EMI/RFI. With over 25 years of engineering and manufacturing experience, ProTek designs TVS devices that provide application specific protection solutions for all electronic equipment/systems.

ProTek Devices Analog Products Division, also manufactures analog interface, control, RF and power management products.

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PATENT INFORMATION: This device is patented under U.S. Patent No. Des. "D456,367S".